CLAIMS

What is claimed is:

- A photoresist comprising:
 a cycloolefin functionalized with a di-ol.
- The photoresist of claim 1, further comprising:an aromatic structure copolymerized with the cycloolefin.
- 3. The photoresist of claim 2, further comprising a molecule bonded to the aromatic structure, wherein the molecule is selected from a group consisting of a hydrogen atom, an alkyl group, or a hydroxyl group.
- 4. The photoresist of claim 1, wherein the di-ol comprises an alkyl functionalized by two hydroxyl groups.
- 5. The photoresist of claim 1, wherein the di-ol further comprises additional functional groups, each functional group being selected from a group consisting of a hydrogen atom, an alkyl group, an aromatic structure, or a cage.
- 6. The photoresist of claim 1, wherein the cycloolefin is an aromatic structure.

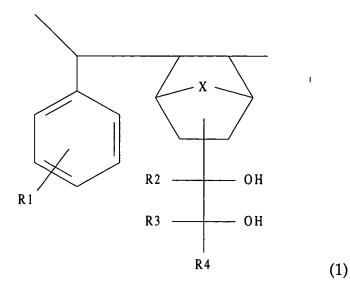
- 7. The photoresist of claim 1, wherein the cycloolefin is a norbornene structure.
- 8. The photoresist of claim 7, wherein the norbornene structure comprises a side-group, wherein the side-group is selected from a group consisting of a carbon atom, and alkyl group, an oxygen atom, or a sulfur atom.
- 9. The photoresist of claim 2, further comprising a photo acid generator (PAG).

14

Attorney Docket No.: 042390.P18259

10. A photoresist comprising:

a copolymerized structure represented by the following molecule



where R1 is a hydrogen atom, an alkyl, or a hydroxyl, where each of R2, R3 and R4 is a hydrogen atom, alkyl, aromatic, and/or cage, and where X is no atom, a carbon atom, an alkyl, an oxygen atom, or a sulfur atom.

11. A method comprising:

depositing a photoresist comprising a cycloolefin functionalized with a di-ol on an underlying layer; and

exposing at least a portion of the photoresist to radiation to form at least a carbonate containing material.

12. The method of claim 11, wherein the carbonate containing material is a ketone.

- 13. The method of claim 11, wherein the carbonate containing material is a aldehyde.
- 14. The method of claim 11, wherein the underlying layer is a substrate.
- 15. The method of claim 11, wherein the photoresist is a negative tone photoresist.
- 16. The method of claim 11, wherein exposing at least a portion of the photoresist to radiation is done through a mask.
- 17. The method of claim 11, wherein the radiation is generated from an EUV exposure tool.
- 18. The method of claim 11, further comprising baking the photoresist.
- 19. The method of claim 11, wherein the photoresist further comprises a first aromatic structure copolymerized with the cycloolefin.
- 20. The method of claim 19, wherein the first aromatic structure is functionalized with a first functional group.

- 21. The method of claim 20, wherein the first functional group is selected from a group consisting of a hydrogen atom, an alkyl group, or a hydroxyl group.
- 22. The method of claim 19, wherein the di-ol comprises an alkyl functionalized by two hydroxyl groups.
- 23. The method of claim 22, wherein the di-ol further comprises a second, a third, and a fourth functional group, wherein each of the second, third, and fourth functional groups is a hydrogen atom, an alkyl group, an aromatic structure, or a cage.

1. 1.

- 24. The method of claim 11, wherein depositing the photoresist on an underlying layer comprises: spin-coating the photoresist on the underlying layer.
- 25. The method of claim 11, further comprising developing the photoresist layer by depositing a developer solution on the photoresist layer.
- 26. The method of claim 25, wherein the developer is TMAH.
- 27. The method of claim 26, wherein the developer is 2.38% TMAH.

